



# In-Situ SEM Investigation of Microstructural Damage Evolution and Strain Relaxation in a Melt-Infiltrated SiC/SiC Composite

Kathy Sevener, Zhe Chen, Sam Daly - The University of Michigan

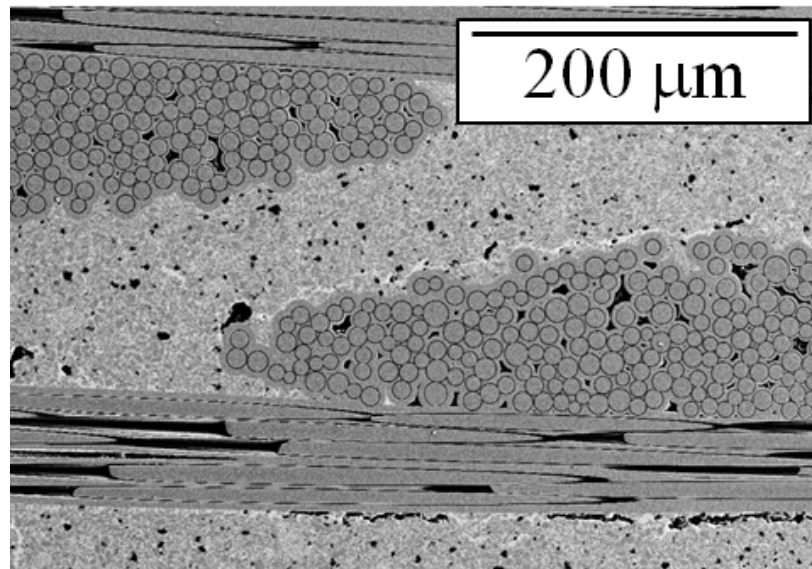
Jared Tracy - Stanford University

Doug Kiser - NASA Glenn Research Center

40th Annual Conference on Composites, Materials, and Structures

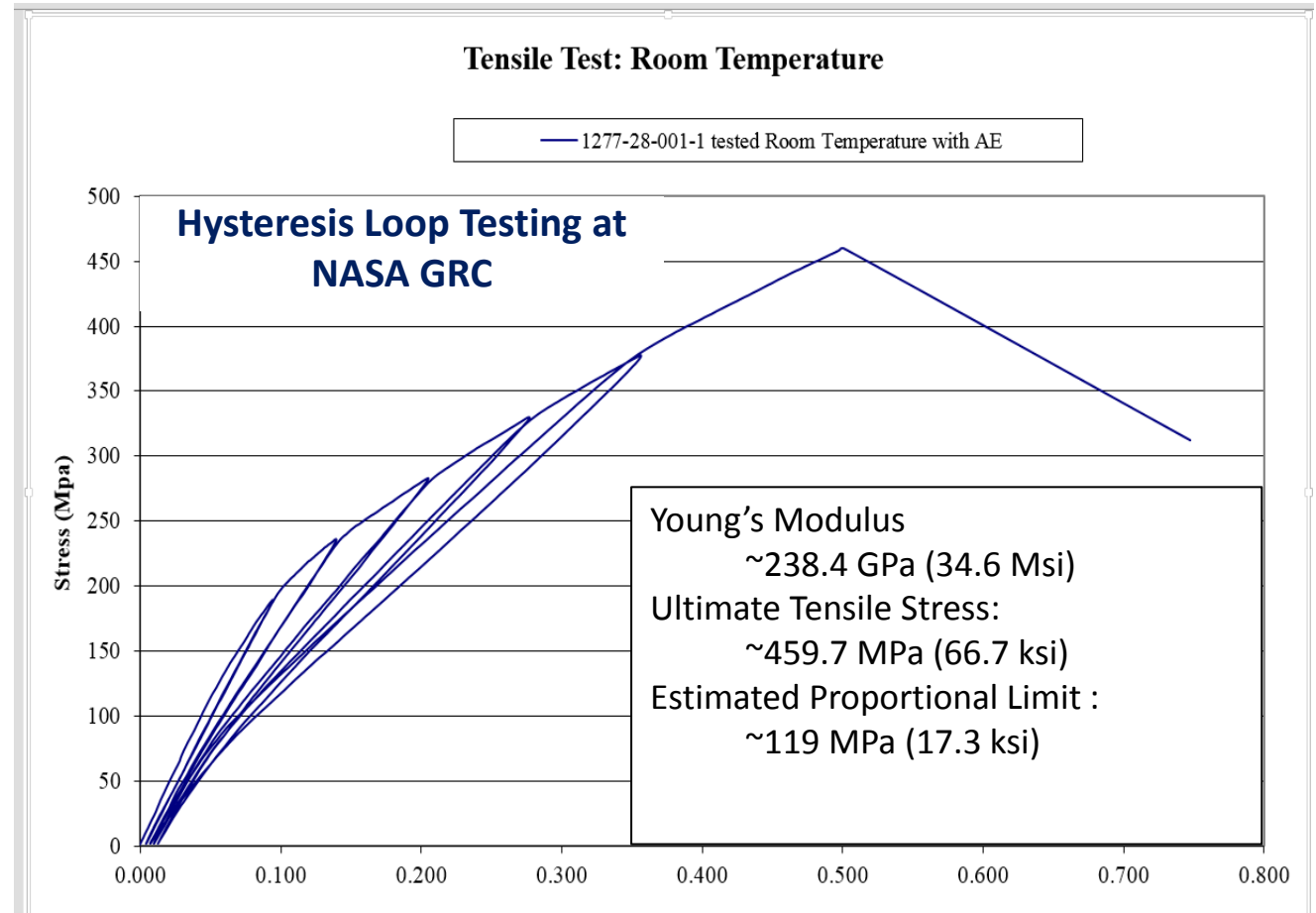
# Motivation – Experimental Data for Modeling

- Robust CMC life prediction capabilities require experimental data for inputs and validation
- Several groups working on environmental degradation models that incorporate matrix cracking and interface debonding
  - few studies report measured crack opening displacements
- NASA GRC characterizing CMCs to support environmental modeling

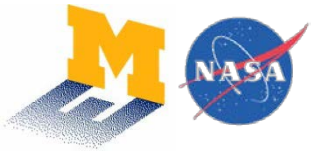


- Sylramic fiber reinforced, slurry cast MI SiC/SiC
- CODs predicted to be very small – too small for traditional DIC
- Apply SEM-DIC using small tensile loading stage in SEM

# Approach



- Load in 5 ksi increments to 30 ksi using small tensile stage
- Measure COD using SEM-DIC and manual methods



# Digital Image Correlation

## Non-contact “optical” method

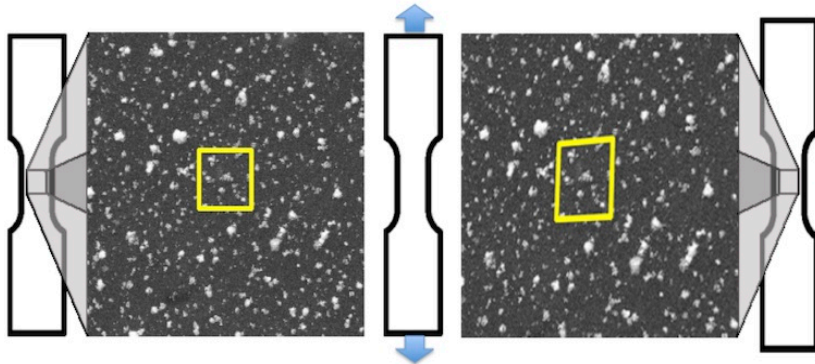
White light, SEM, AFM

## Requires surface to have a random tracking pattern

Isotropic, high-contrast, random

## Surface pattern analyzed in small subsets

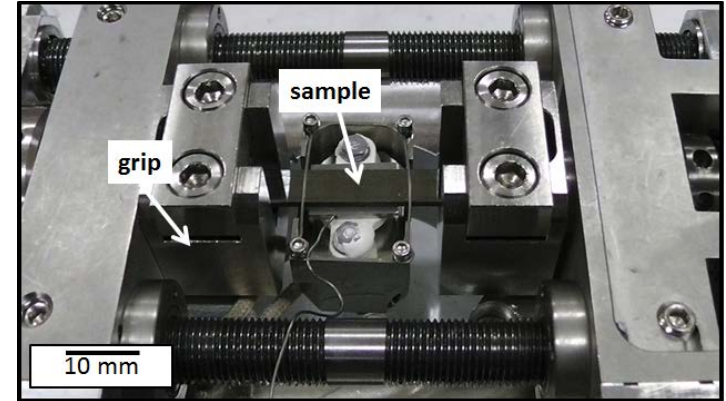
Grayscale intensity within subsets is tracked as sample is deformed.



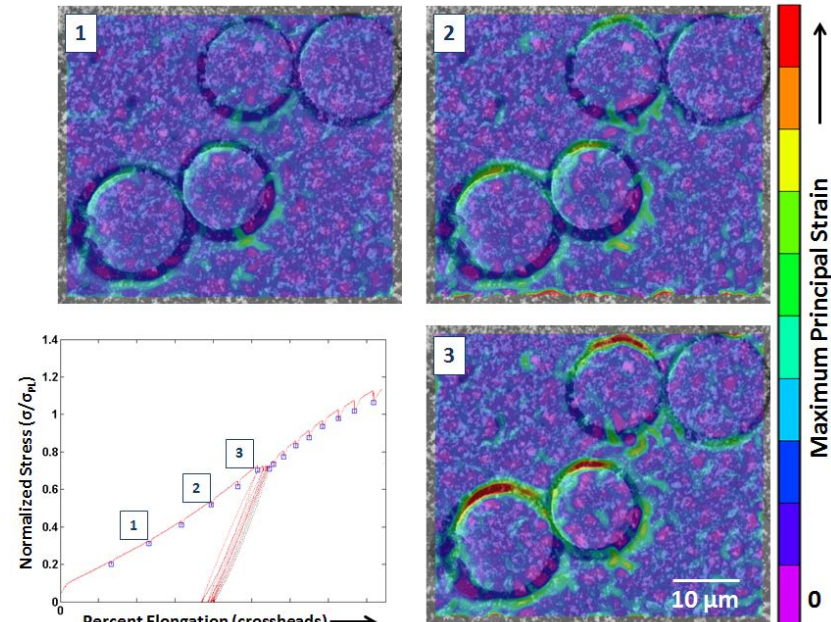
Sutton M.A., et al. (1983), *Image and Vision Computing*, **1**(3): 133-139.  
Bruck, H.A., et al. (1989), *Exp. Mech.*, **29**: 261-267.



## In-SEM Miniature Tension/Compression Stage



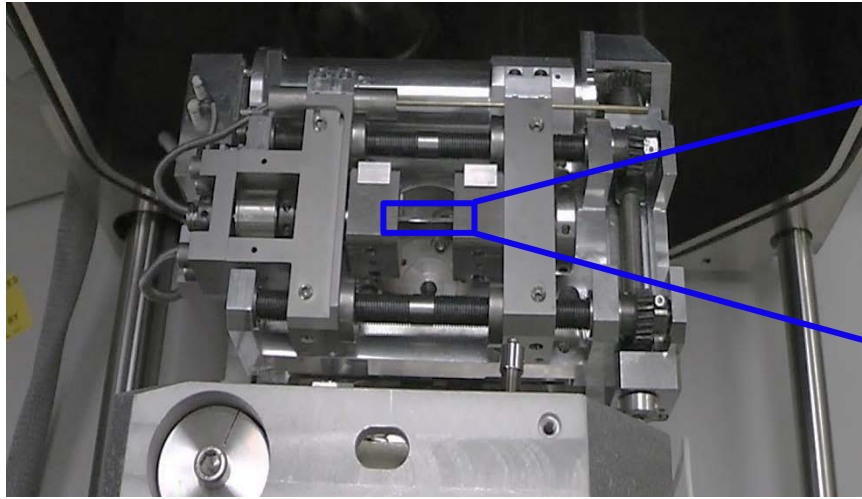
## SEM-DIC applied to CMCs



Tracy, J.M., et al. Cocoa Beach 2014

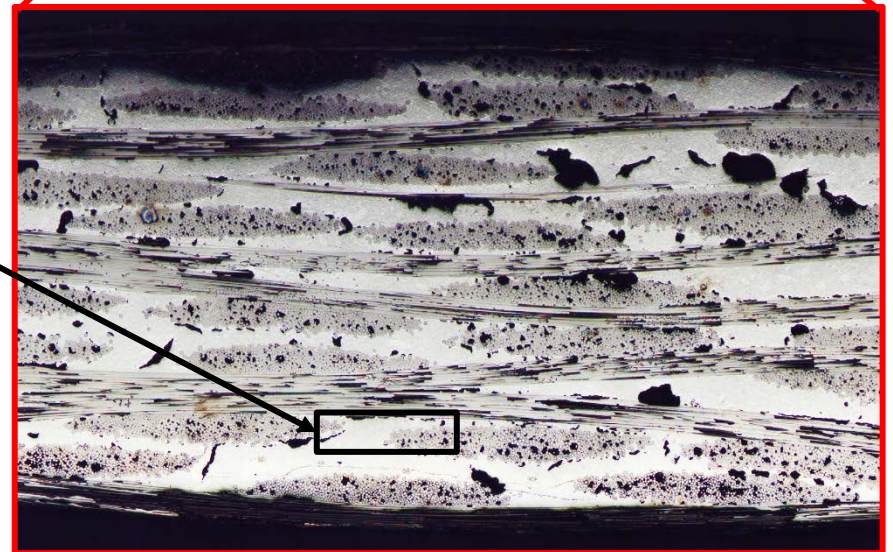
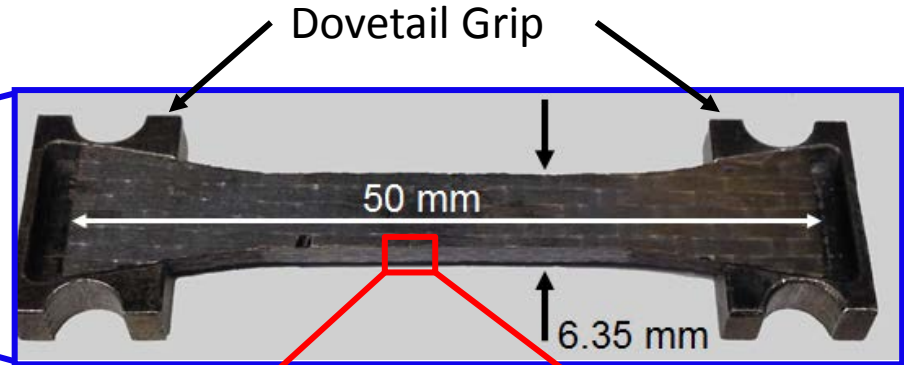


# Loading and Imaging Configuration

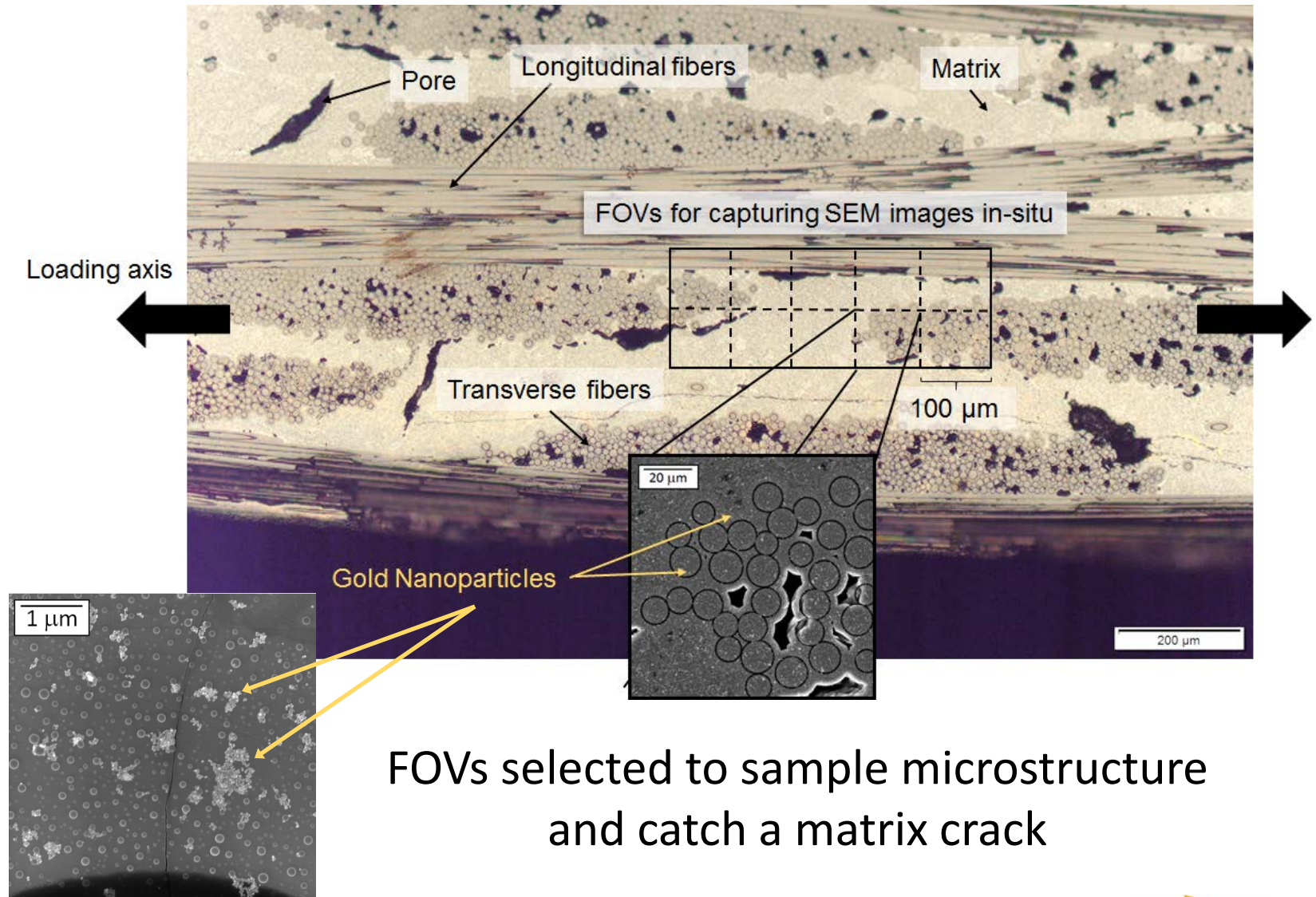


← Loading Direction →

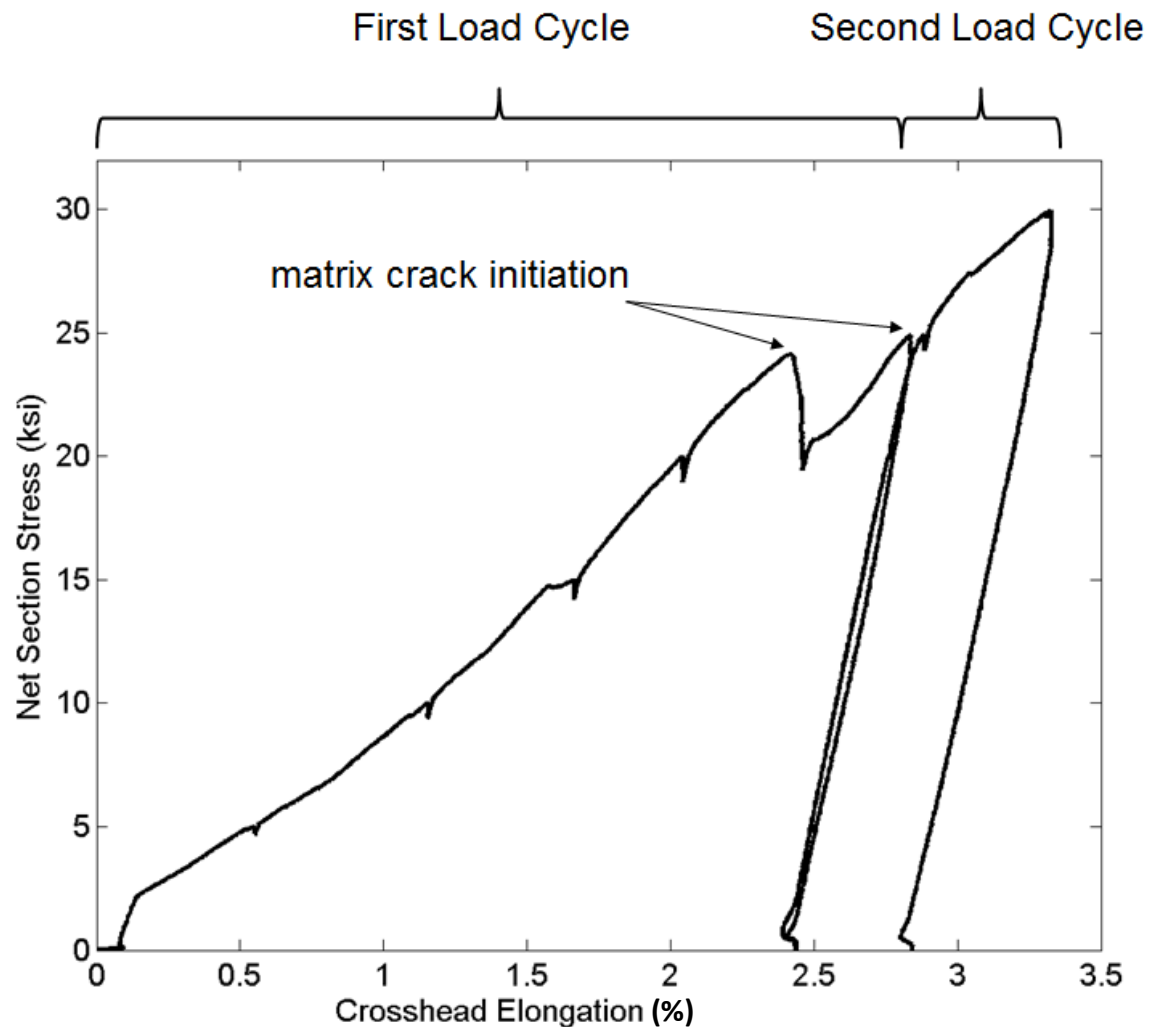
Area analyzed was a  $200\ \mu\text{m} \times 500\ \mu\text{m}$  rectangle located  $\approx 1.4\ \text{mm}$  left and  $0.7\ \text{mm}$  below centroid of gage section



# Initial Fields of View (FOVs)

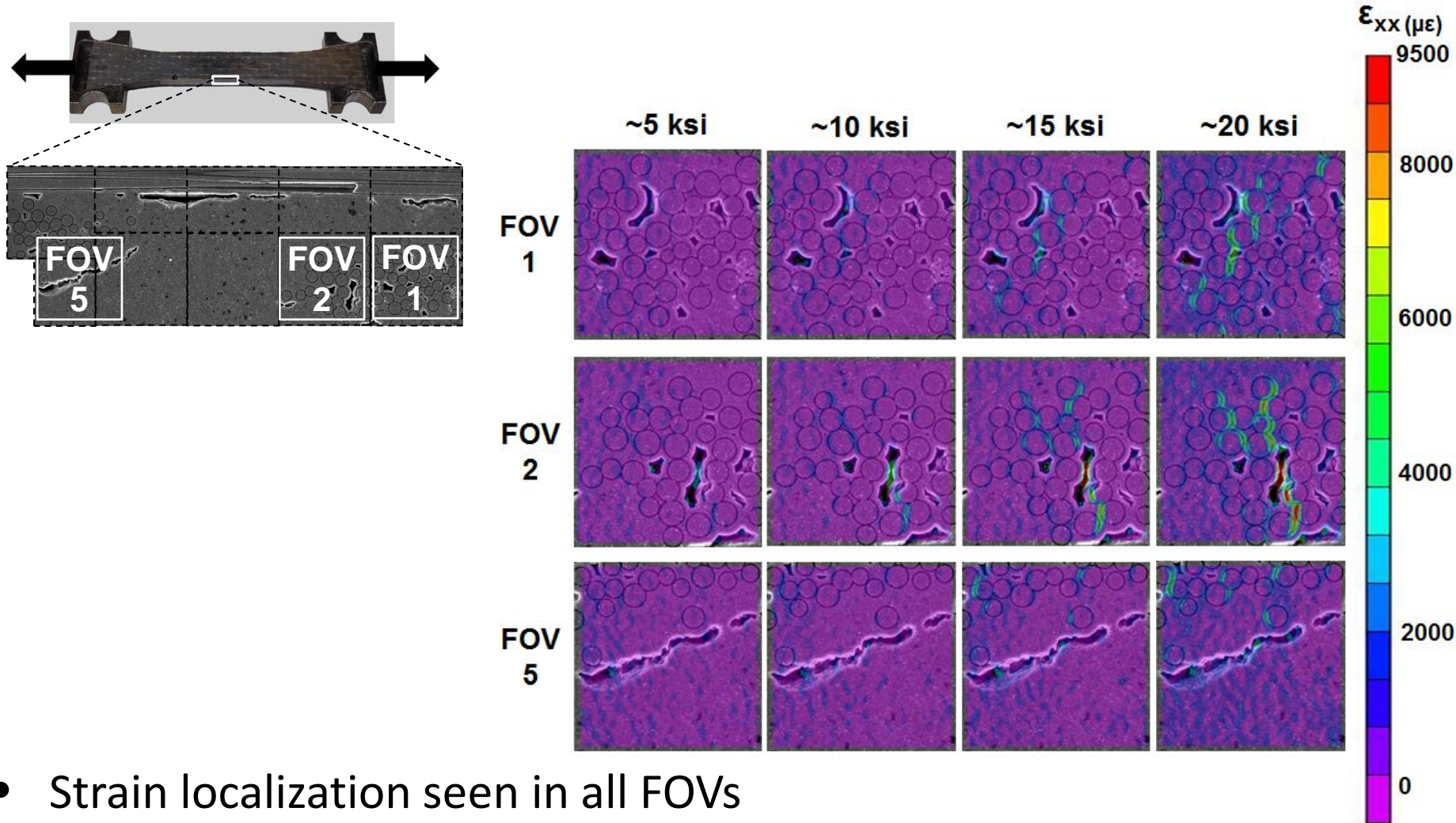


- Sample loaded in tension at ~5 ksi stress increments
- Loading paused at each stress increment to capture SEM images
- Images captured after load relaxed
- Matrix cracks formed between 20 and 25 ksi of initial load cycle, but outside of imaging area.
- Sample unloaded/reloaded to capture matrix crack openings displacements in new AOI





# Damage Evolution Before Matrix Cracking

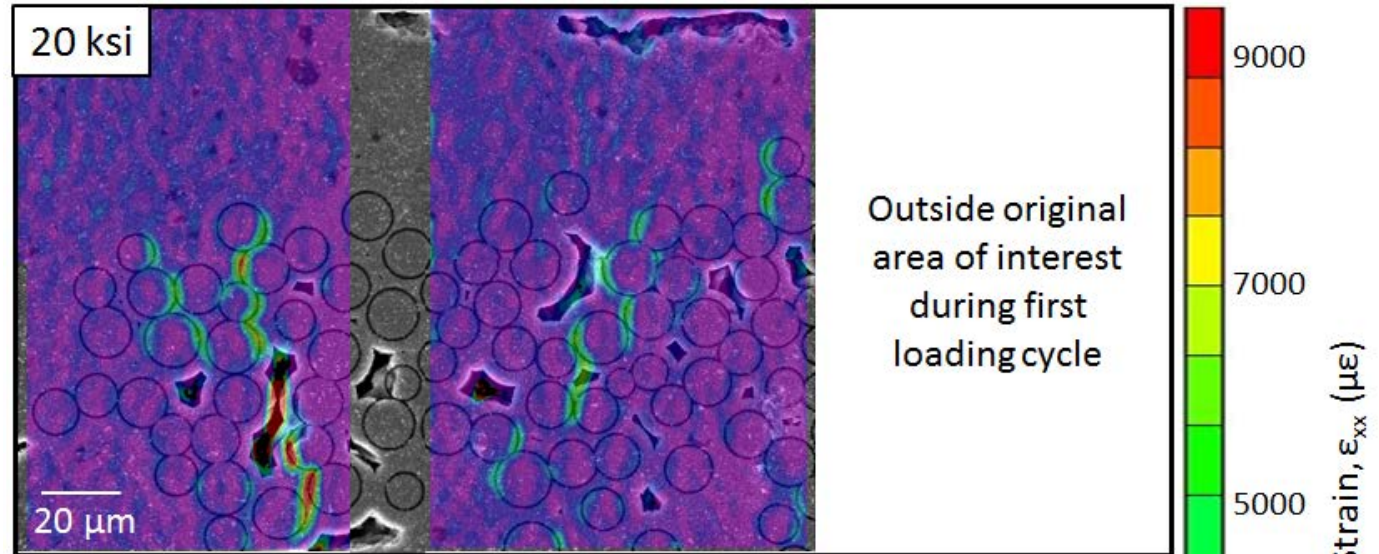


- Strain localization seen in all FOVs
- Strain localization observed ~ 10 ksi

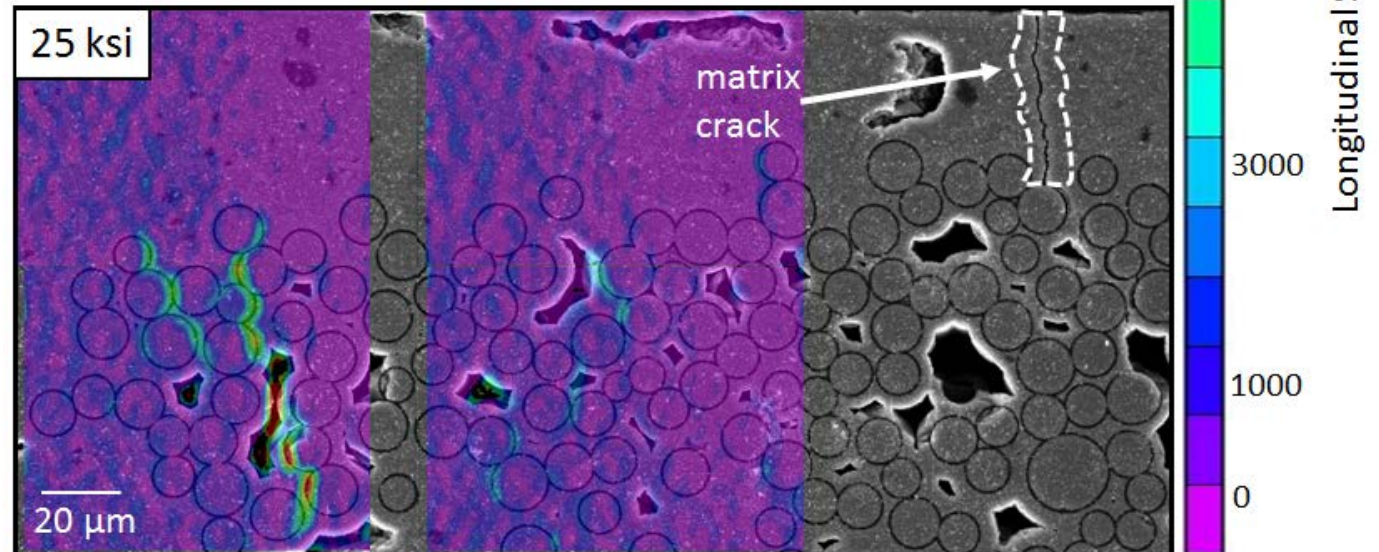


# Strain Relaxation Adjacent to Matrix Crack

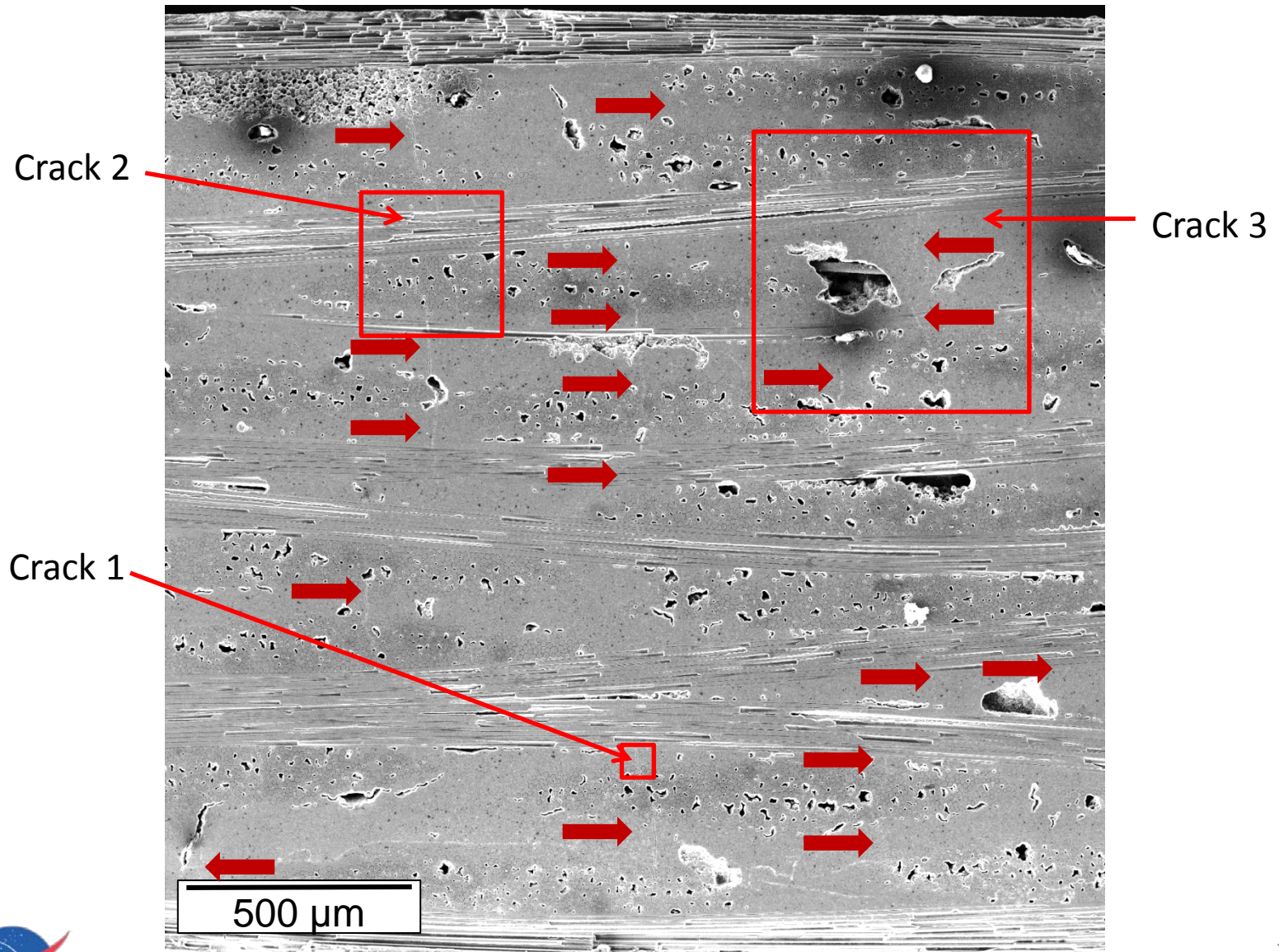
Prior to first  
matrix cracking



After first  
matrix cracking

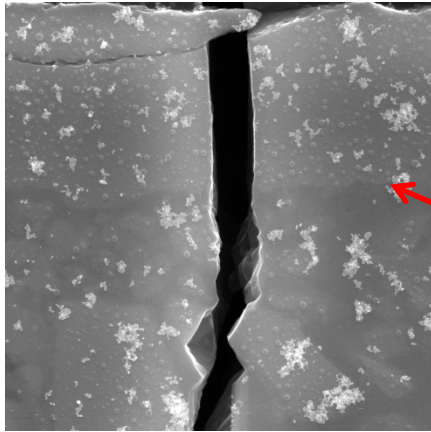


# Cracks observed across the cross-section

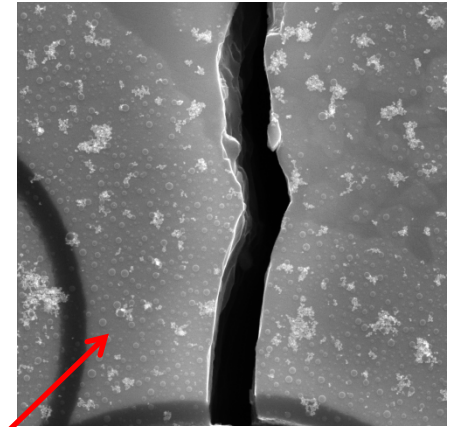
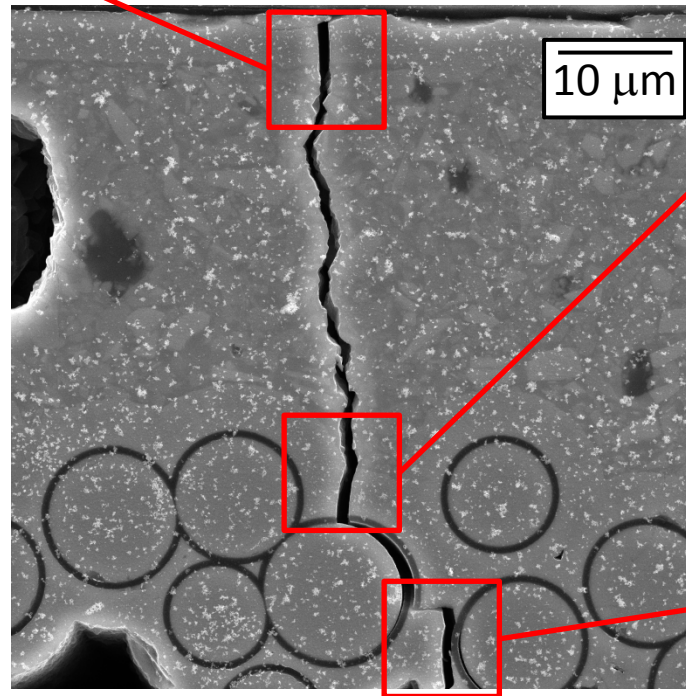




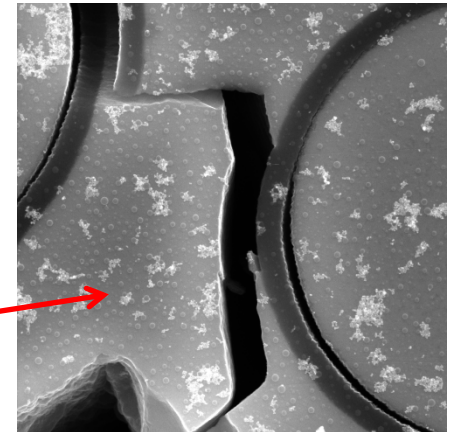
# Crack 1



Location 2



Location 1



Location 3

- All high mag FOVs are 10 μm
- High mag FOVs shown at ~30ksi



$\sigma \sim 10$  ksi

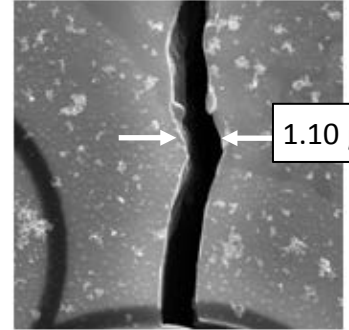
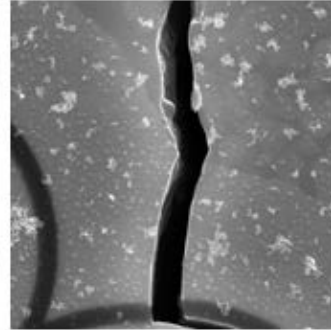
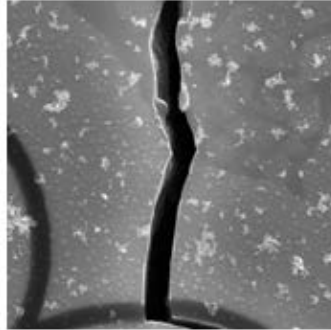
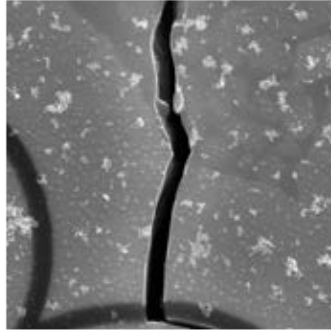
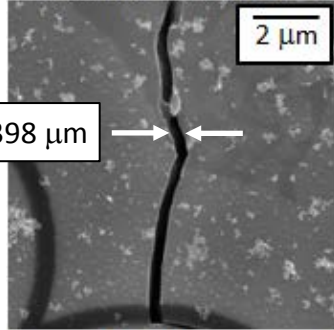
$\sigma \sim 15$  ksi

$\sigma \sim 20$  ksi

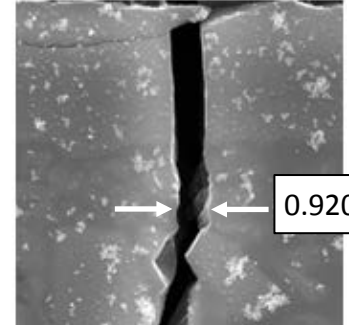
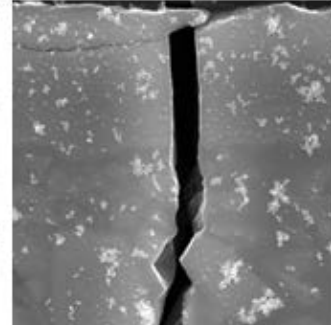
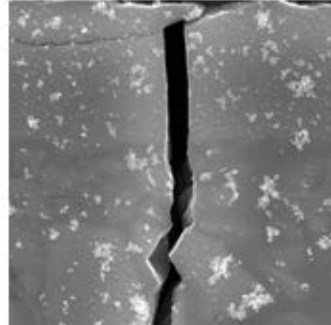
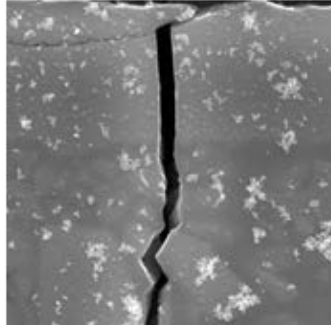
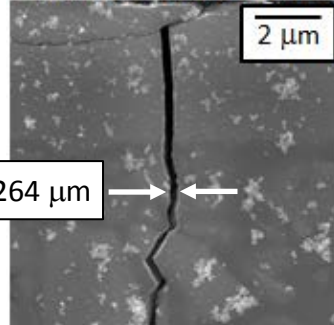
$\sigma \sim 25$  ksi

$\sigma \sim 30$  ksi

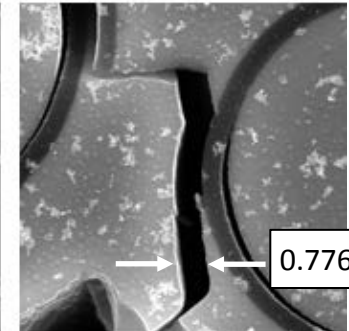
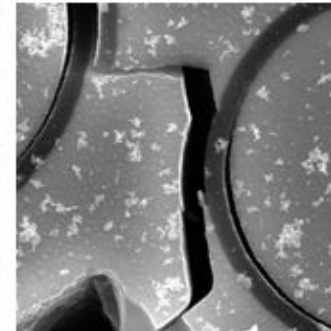
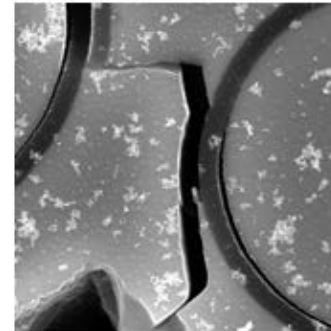
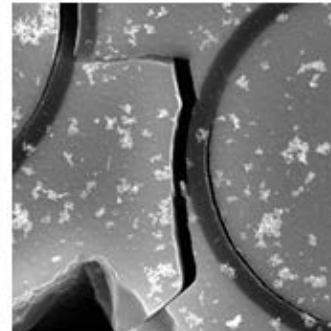
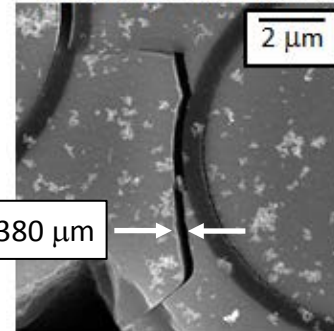
Crack 1 Location 1



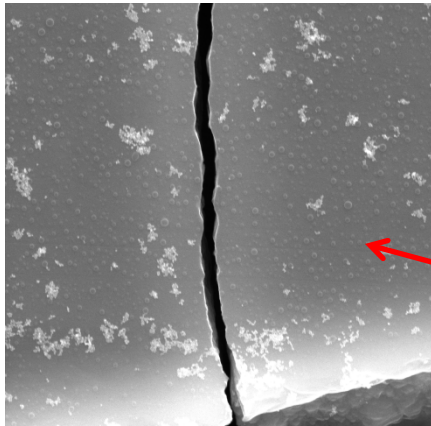
Crack 1 Location 2



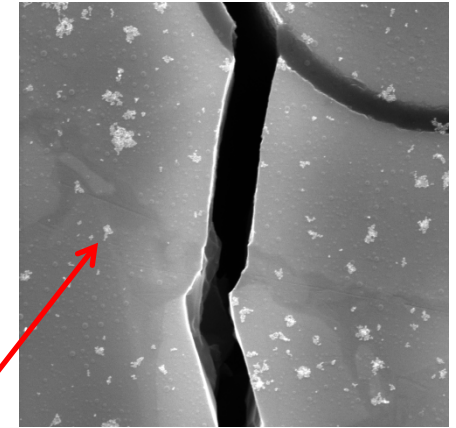
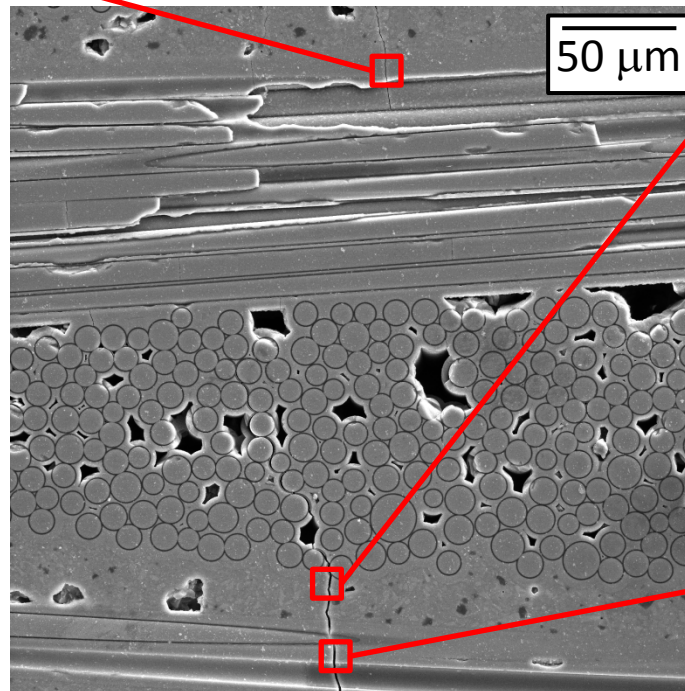
Crack 1 Location 3



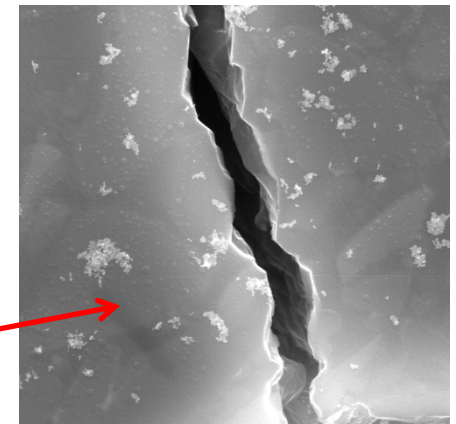
# Crack 2



Location 3



Location 2



Location 1

- All high mag FOVs are 10 μm
- High mag FOVs shown at ~30ksi

$\sigma \sim 10$  ksi

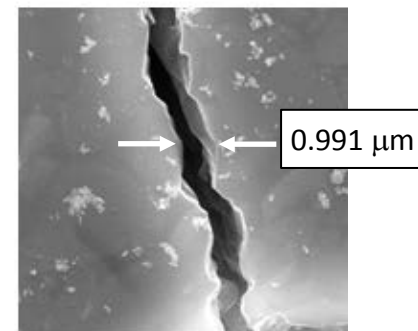
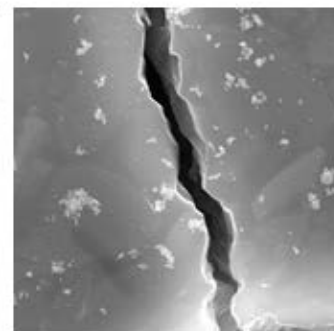
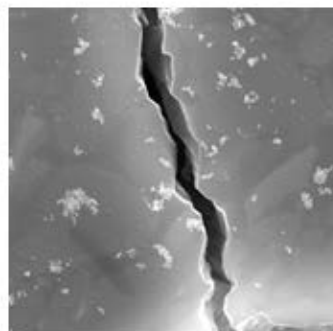
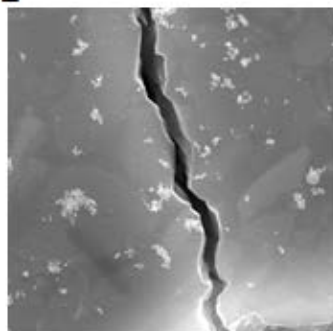
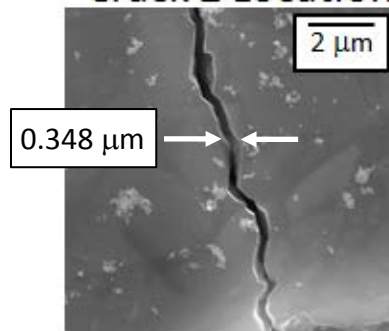
$\sigma \sim 15$  ksi

$\sigma \sim 20$  ksi

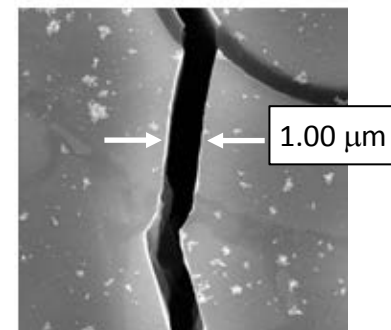
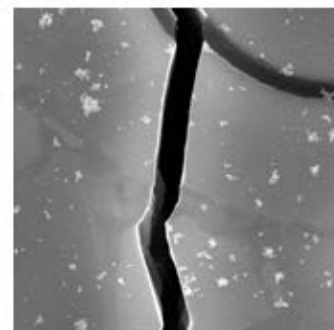
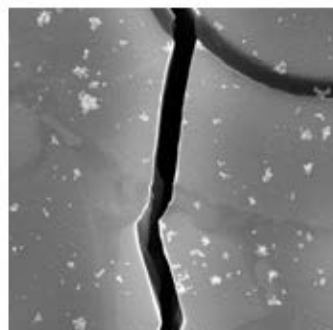
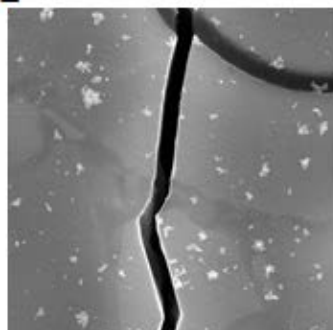
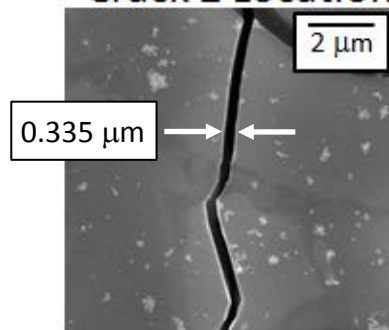
$\sigma \sim 25$  ksi

$\sigma \sim 30$  ksi

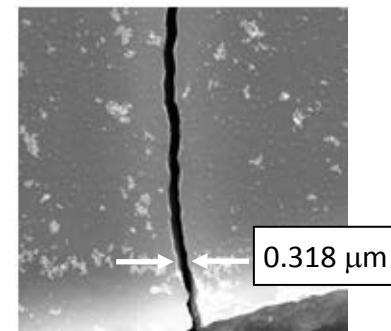
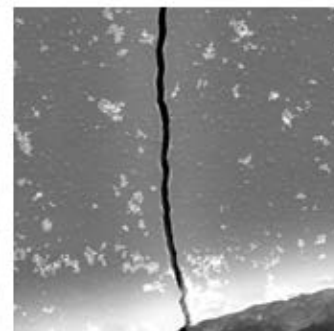
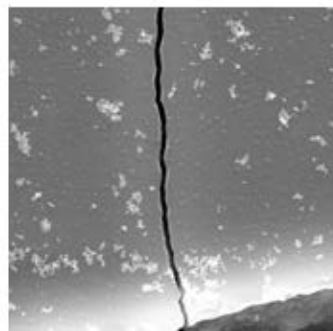
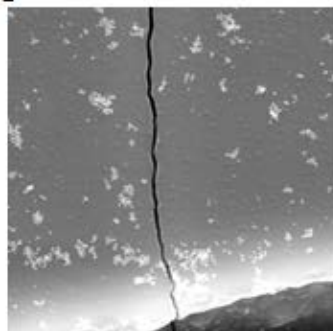
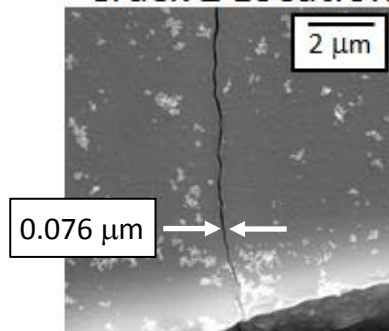
Crack 2 Location 1



Crack 2 Location 2

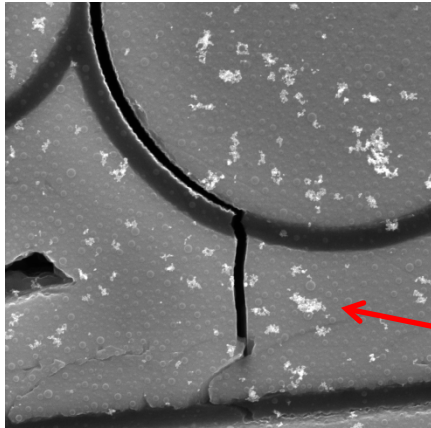


Crack 2 Location 3

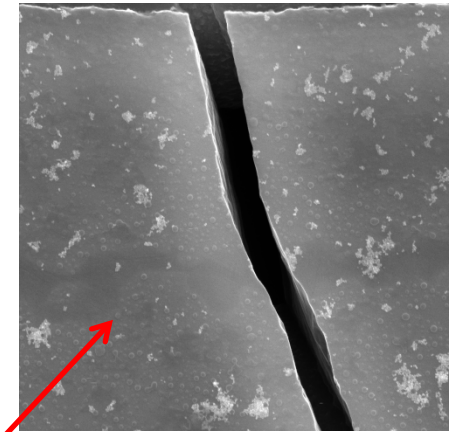
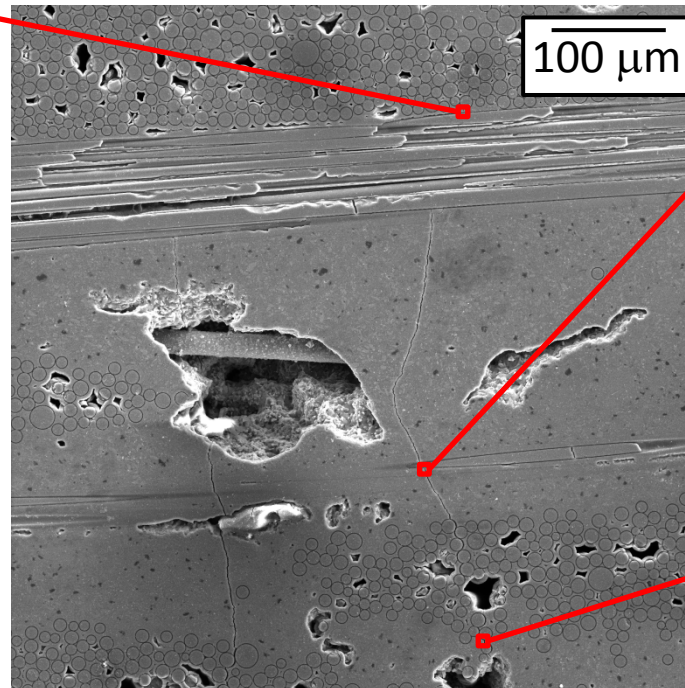




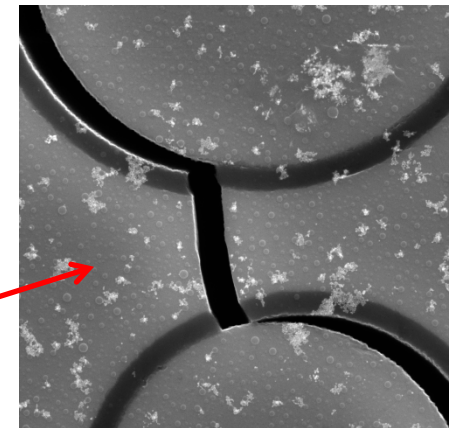
# Crack 3



Location 3



Location 2



Location 1

- All high mag FOVs are 10 μm
- High mag FOVs shown at ~30ksi

$\sigma \sim 10$  ksi

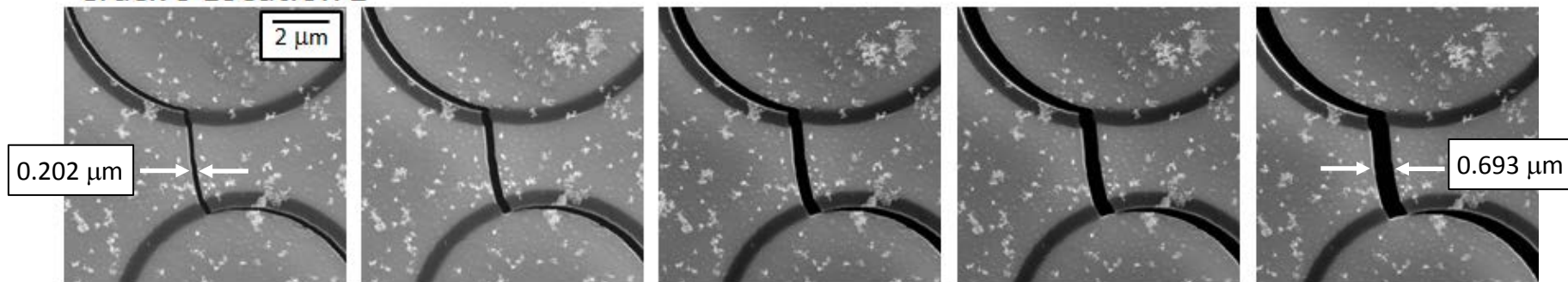
$\sigma \sim 15$  ksi

$\sigma \sim 20$  ksi

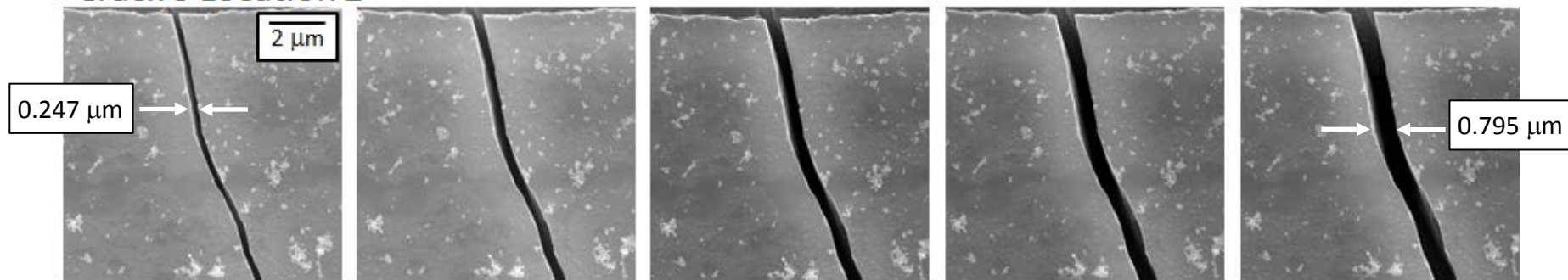
$\sigma \sim 25$  ksi

$\sigma \sim 30$  ksi

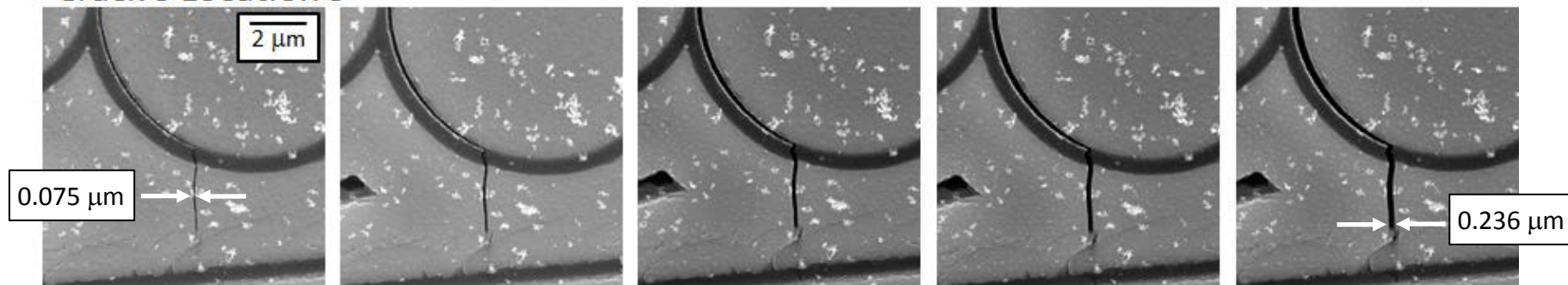
Crack 3 Location 1



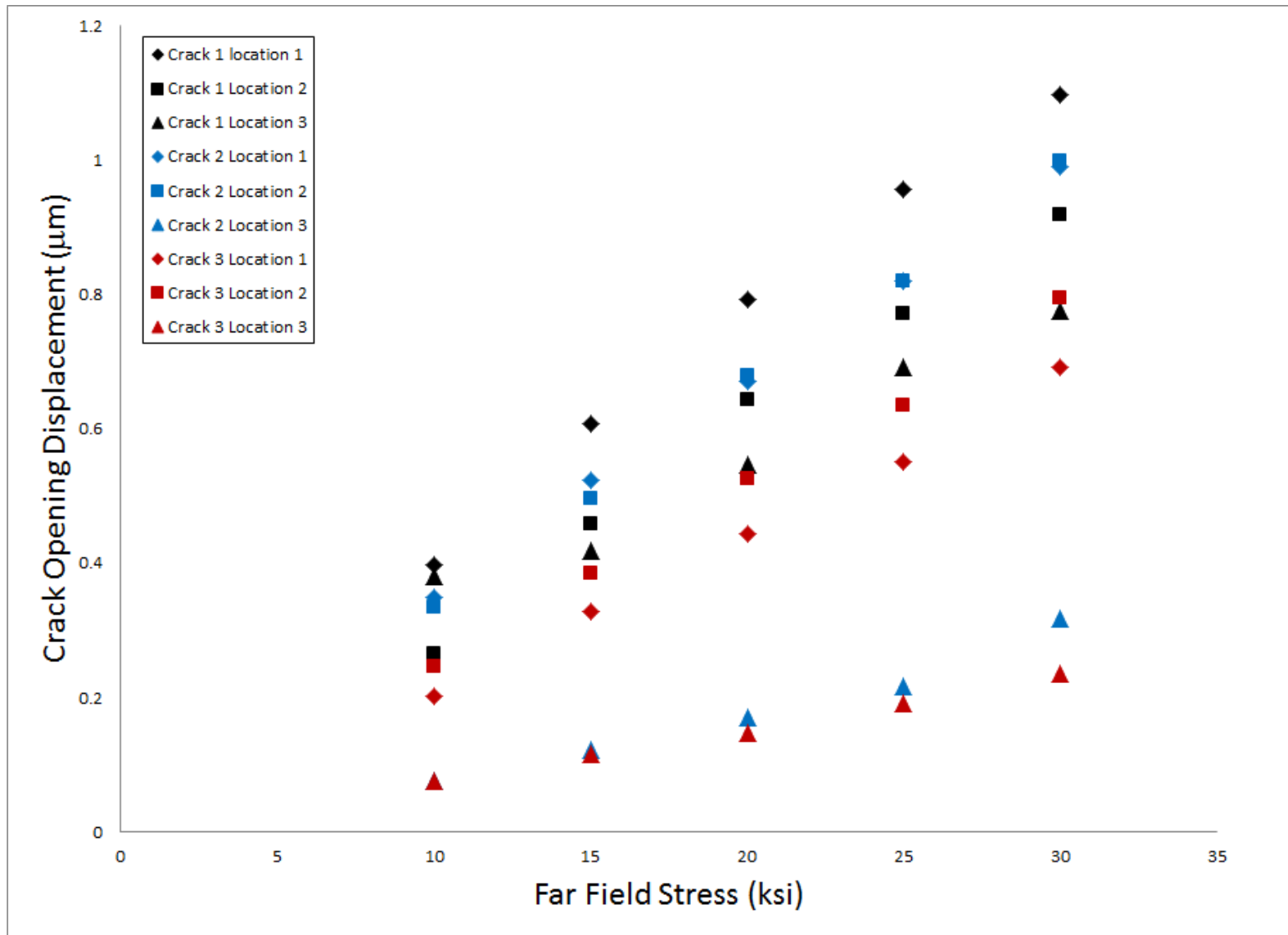
Crack 3 Location 2



Crack 3 Location 3

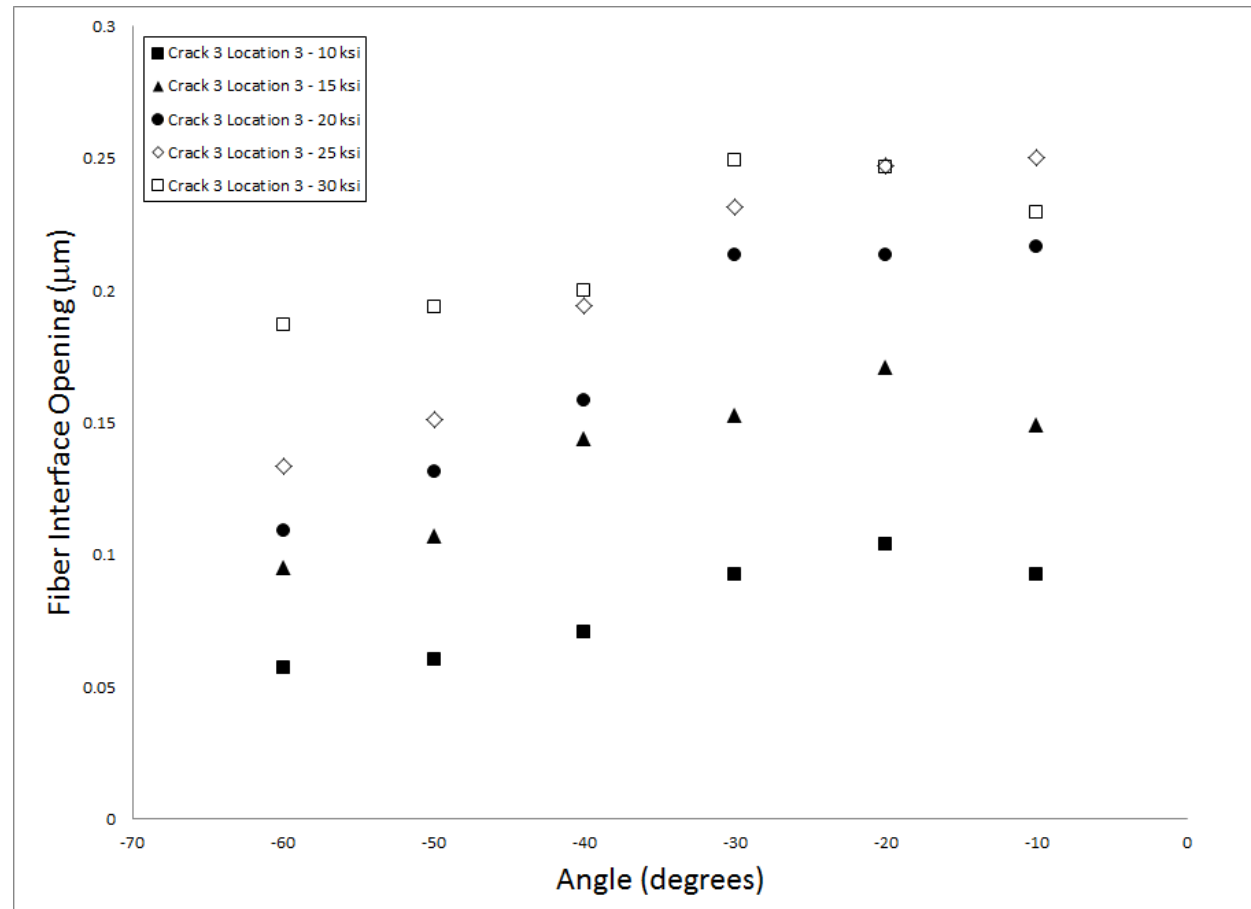
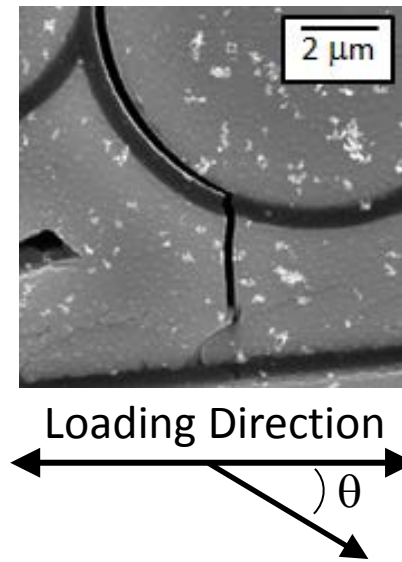


# Matrix Crack Opening Exhibits Variability





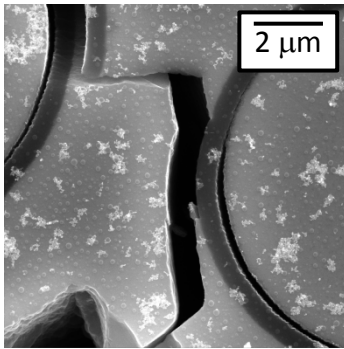
# Interface Opening Exhibits Variability



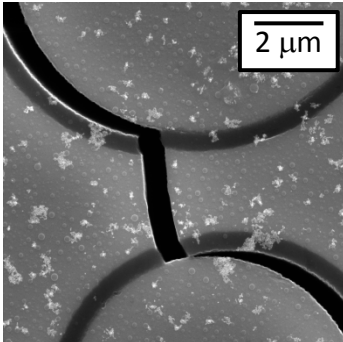
- Expect opening max along direction of stress max
- Stress component along opening direction =  $\sigma \cos(\theta)$

# Cracking Along Interfaces

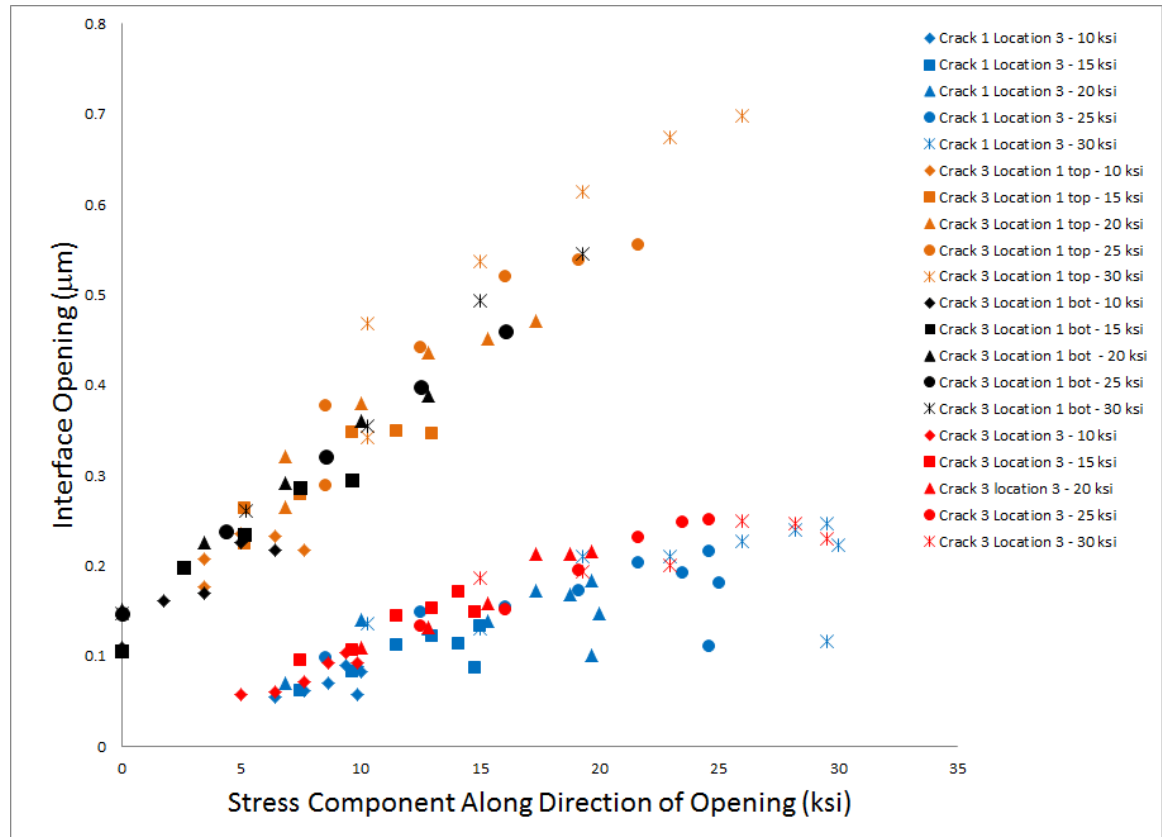
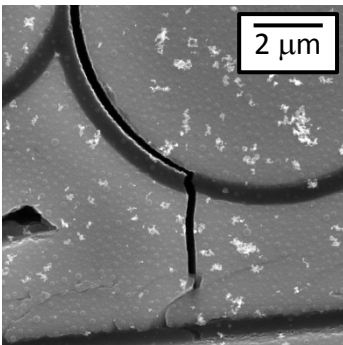
Crack 1 Location 3



Crack 3 Location 1

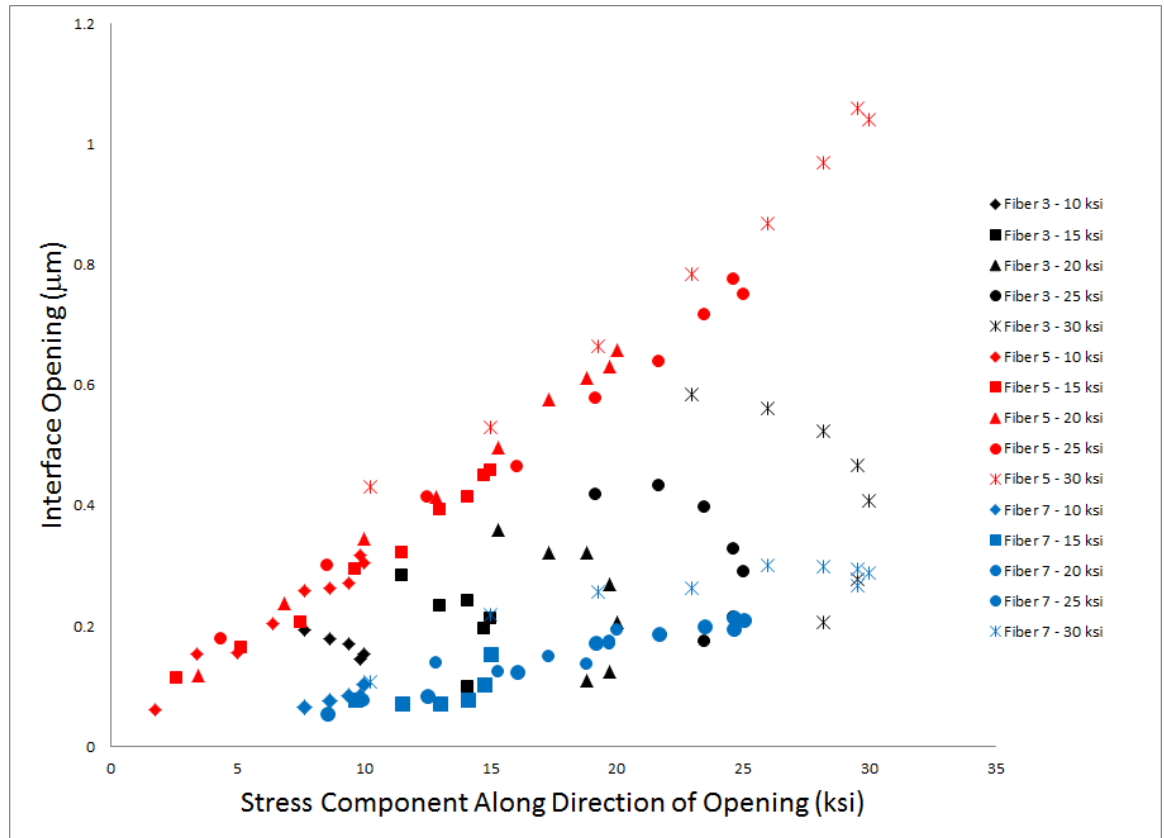
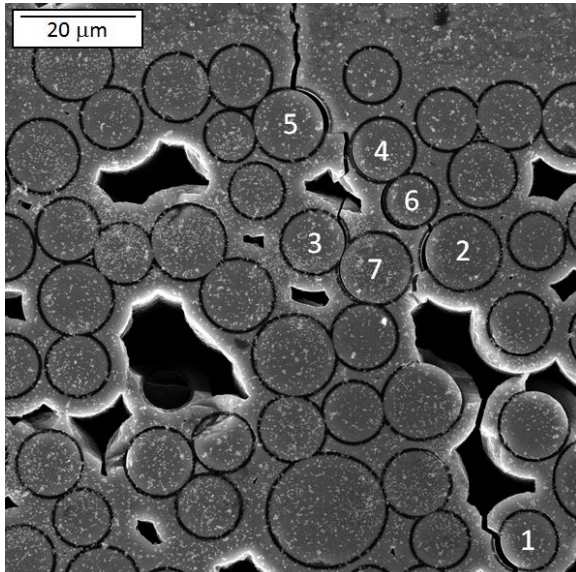


Crack 3 Location 3



- Some openings follow max global stress, some do not
- Cannot see the entire opening in the FOV

# Multiple Fibers Along Crack 1



- Again some openings follow max global stress, some do not
- Local stress state is unknown



# Future Work

## In-situ Testing and Analysis

- Couple macroscale DIC with SEM-DIC to examine the multiscale nature of damage evolution and the influence of microstructure on crack growth
  - Couple high speed imaging with macroscale DIC to examine and quantify the distances over which matrix cracks influence neighboring cracks
- SEM-DIC at ultrafine length scales (FOVs < 5  $\mu\text{m}$ ) to probe mechanical response in matrix constituents – available constituent properties are mostly approximations
- Examine environmental effects on subcritical crack growth
  - investigate the effects of fatigue, humidity, combustion gases on crack growth in both coatings and matrix
  - SEM/ESEM (microscale) or an environmental chamber (macroscale)

## Modeling

- Statistical modeling of the influence/impact of microstructural features on damage evolution (for data collected in all of the above studies)
  - Quantify and correlate measurements of microstructural features with damage observations
  - Use results to develop models describing the influence of microstructure on damage evolution.



# Summary and Conclusions

- A slurry cast MI SiC/SiC sample was loaded to a global stress of 30 ksi in a small tensile stage within an SEM
- SEM-DIC and traditional analysis was used to quantified damage
- Damage at fiber/matrix interfaces at global stresses as low as 5 ksi
- After initial matrix cracking, strain relaxation was observed adjacent to matrix cracks
- Crack opening displacements varied from 0.2 to 1.5  $\mu\text{m}$  at a global stress of 30 ksi
- Interface openings exhibited angular variability where maximum opening was not always along the global loading axis - opening may follow a local maximum

